

Card Wrapping Fixture



Two Radius Tests for Module Resistance

BQ Technologies' wrapping fixture is designed to apply bending stress to a module embedded within a card's body in order to check gluing resistance. The test fixture has the capability to perform at two bending radii: 20mm and 25mm.

The wrapping fixture features a horizontal design with splayed feet and aggressive no-slip rubber pads for stability. It is manufactured of aerospace-grade aluminum alloy with a hard anodized, scratch-resistant, durable finish to provide years of rigorous testing and trouble-free service.

BQ Technologies' Card Wrapping Fixture is designed to perform this test according to the following standards:

- Mastercard CQM

Ordering Details

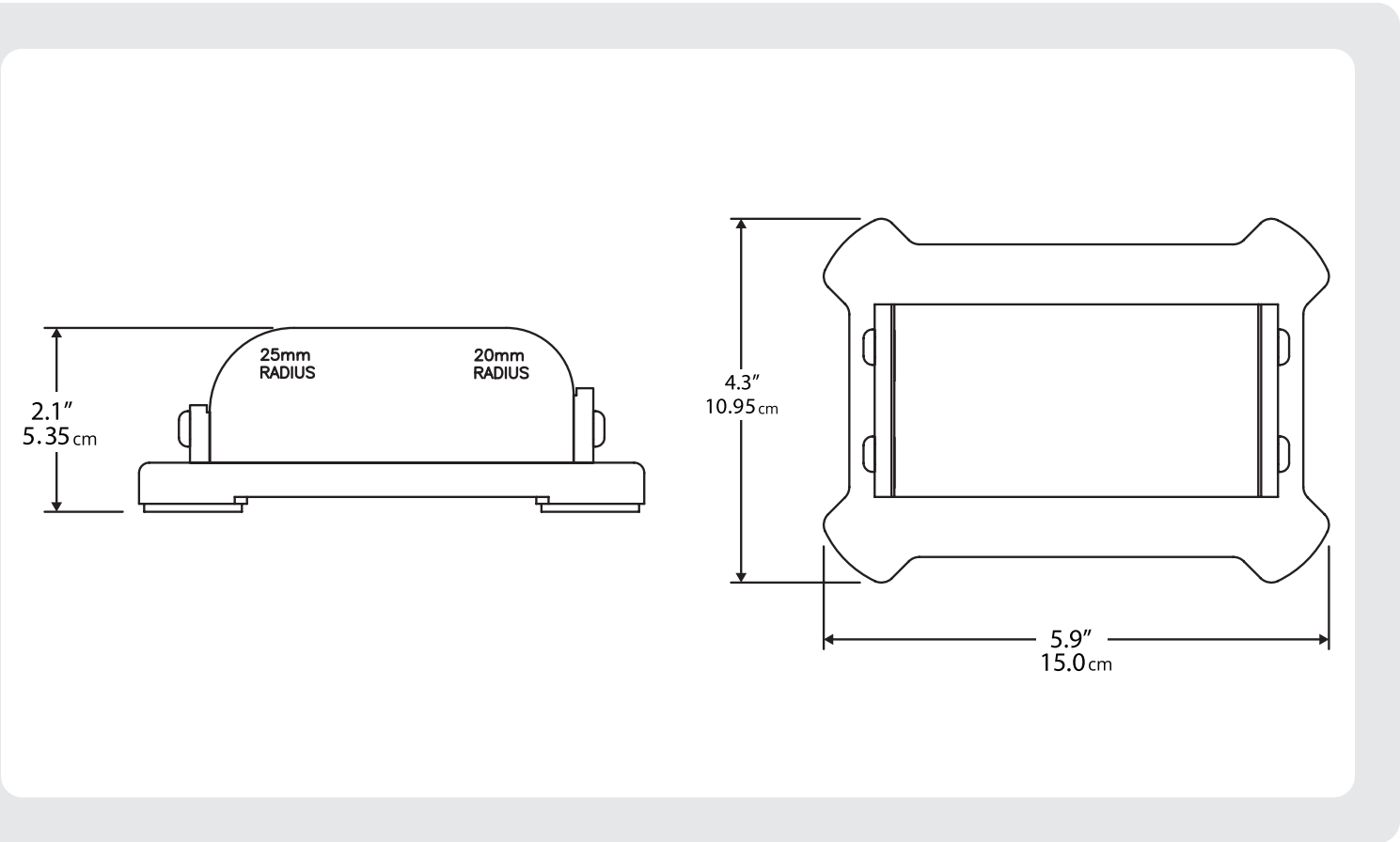
Part #	Description
906710	Wrapping Test Fixture

Specifications

Weight

- 2.5 lbs.

Dimensions



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Specifications are subject to change. Copyright 2026. BQ CQM Card Wrapping 082526 rev0